

# 74AHC541 Octal Buffer/Line Driver with 3-State Outputs

# GENERAL DESCRIPTION

The 74AHC541 is an octal buffer/line driver with 3-state outputs, which can accept supply voltage range from 2.0V to 5.5V.

The 3-state control gate is a two-input AND gate with active low inputs.  $\overline{OE}1$  and  $\overline{OE}2$  are two output enable inputs. When  $\overline{OE}1$  and  $\overline{OE}2$  are low, data transmits from An inputs to the Yn outputs. When  $\overline{OE}1$  or  $\overline{OE}2$  is high, all outputs are in high-impedance state.

 $\overline{\text{OE}}1$  and  $\overline{\text{OE}}2$  should be connected to  $V_{\text{CC}}$  by using a pull-up resistor to ensure the high-impedance state in the period of power-up or power-down, and the minimum of the resistor depends on the current-sinking capability of the driver.

# **FEATURES**

- Wide Supply Voltage Range: 2.0V to 5.5V
- +8mA/-8mA Output Current
- 3-State Buffers
- -40°C to +125°C Operating Temperature Range
- Available in Green SOIC-20 and TSSOP-20 Packages

# **APPLICATIONS**

Mother Board for Server, PC and Notebook Pad Telecom Equipment LED Display Industrial/Medical Equipment

# **FUNCTION TABLE**

	OUTPUT		
OE1	OE2	An	Yn
L	L	L	L
L	L	Н	Н
Н	X	X	Z
X	Н	X	Z

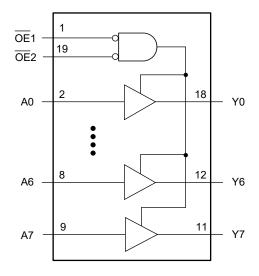
H = High Voltage Level

L = Low Voltage Level

Z = High-Impedance State

X = Don't Care

# **LOGIC DIAGRAM**

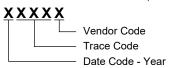


# PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
74AHC541	SOIC-20	-40°C to +125°C 74AHC541XS20G/TR		74AHC541XS20 XXXXX	Tape and Reel, 1500
74AHC541	TSSOP-20	-40°C to +125°C	74AHC541XTS20G/TR	05RXTS20 XXXXX	Tape and Reel, 4000

#### MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

# ABSOLUTE MAXIMUM RATINGS (1)

Supply Voltage, V <sub>CC</sub> 0.5V to 7.0V
Input Voltage, V <sub>1</sub> <sup>(2)</sup> 0.5V to 7.0V
Output Voltage, $V_0^{(2)}$ 0.5V to MIN (7.0V, $V_{CC}$ + 0.5V)
Input Clamping Current, I <sub>IK</sub> (V <sub>I</sub> < 0V)20mA
Output Clamping Current, $I_{OK}$ ( $V_O < 0V$ or $V_O > V_{CC}$ ) $\pm 20$ mA
Output Current, $I_O$ ( $V_O$ < 0V to $V_{CC}$ )±25mA
Supply Current, I <sub>CC</sub>
Ground Current, I <sub>GND</sub> 75mA
Junction Temperature (3)+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (Soldering, 10s)+260°C
ESD Susceptibility
HBM4000V
CDM1000V

#### RECOMMENDED OPERATING CONDITIONS

Supply Voltage, V <sub>CC</sub>	2.0V to 5.5V
Input Voltage, V <sub>I</sub>	0V to 5.5V
Output Voltage, Vo	0V to V <sub>CC</sub>
Output Current, Io	±8mA
Input Transition Rise and Fall Rate, $\Delta t/\Delta V$	
V <sub>CC</sub> = 3.3V ± 0.3V	100ns/V (MAX)
V <sub>CC</sub> = 5.0V ± 0.5V	20ns/V (MAX)
Operating Temperature Range	40°C to +125°C

#### **OVERSTRESS CAUTION**

- 1. Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.
- 2. The input and output voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- 3. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

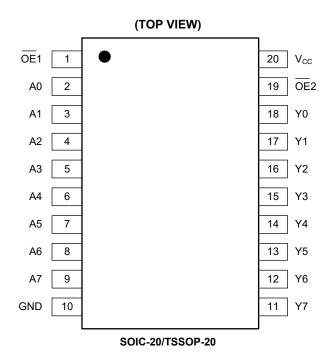
#### **ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

#### **DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

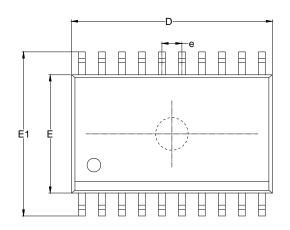
# **PIN CONFIGURATION**

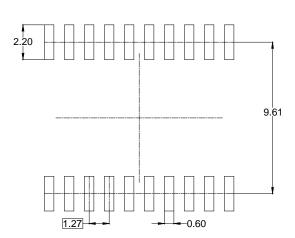


# **PIN DESCRIPTION**

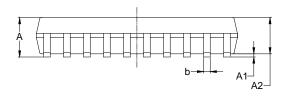
PIN	NAME	FUNCTION		
1, 19	OE1, OE2	Output Enable Inputs (Active Low).		
2, 3, 4, 5, 6, 7, 8, 9	A0, A1, A2, A3, A4, A5, A6, A7	Data Inputs.		
18, 17, 16, 15, 14, 13, 12, 11	Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	Data Outputs.		
10	GND	Ground.		
20	V <sub>CC</sub>	Supply Voltage.		

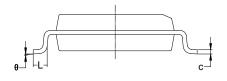
# **PACKAGE OUTLINE DIMENSIONS** SOIC-20





RECOMMENDED LAND PATTERN (Unit: mm)





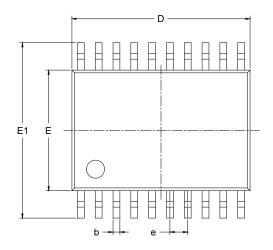
Symbol		nsions meters	Dimensions In Inches		
	MIN	MIN MAX		MAX	
А	A 2.350 2.650		0.093	0.104	
A1	0.100	0.300	0.004	0.012	
A2	2.100	2.500	0.083	0.098	
b	0.330	0.510	0.013	0.020	
С	0.204	0.330	0.008	0.013	
D	12.520	13.000	0.493	0.512	
Е	7.400	7.600	0.291	0.299	
E1	10.210	10.610	0.402	0.418	
е	1.27	1.27 BSC		BSC	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

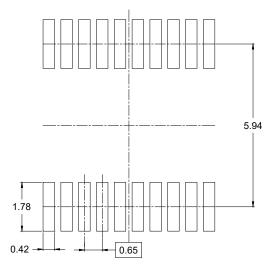
- Body dimensions do not include mode flash or protrusion.
  This drawing is subject to change without notice.



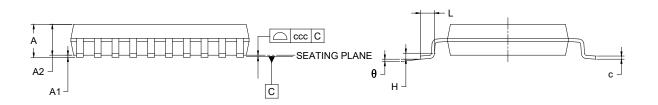
# **PACKAGE OUTLINE DIMENSIONS**

# TSSOP-20





RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters					
Symbol	MIN	MOD	MAX			
Α	-	-	1.200			
A1	0.050	-	0.150			
A2	0.800	-	1.050			
b	0.190	-	0.300			
С	0.090	0.090 -				
D	6.400	-	6.600			
E	4.300	-	4.500			
E1	6.200	6.200 -				
е		0.650 BSC				
L	0.450	0.750				
Н	0.250 TYP					
θ	0° - 8°					
ccc	0.100					

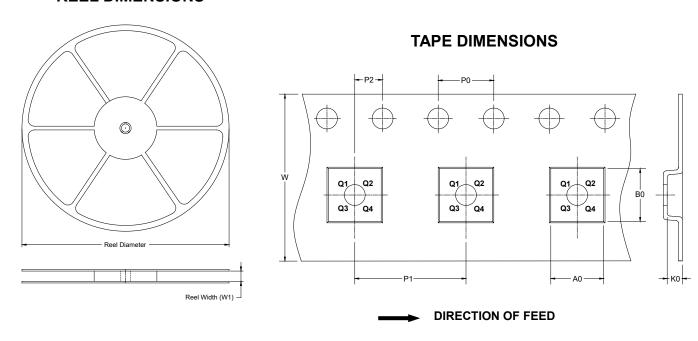
# NOTES:

- 1. Body dimensions do not include mode flash or protrusion.
- This drawing is subject to change without notice.
  Reference JEDEC MO-153.



# TAPE AND REEL INFORMATION

# **REEL DIMENSIONS**

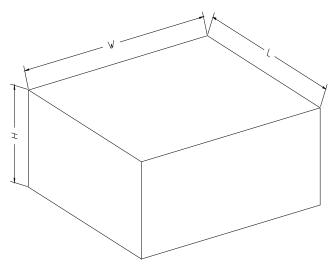


NOTE: The picture is only for reference. Please make the object as the standard.

# **KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-20	13"	24.4	10.90	13.30	3.00	4.0	12.0	2.0	24.0	Q1
TSSOP-20	13"	16.4	6.80	6.90	1.50	4.0	8.0	2.0	16.0	Q1

# **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

# **KEY PARAMETER LIST OF CARTON BOX**

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5